BGA2851

MMIC wideband amplifier

Rev. 3 — 13 July 2015

Product data sheet

1. Product profile

1.1 General description

Silicon Monolithic Microwave Integrated Circuit (MMIC) wideband amplifier with internal matching circuit in a 6-pin SOT363 plastic SMD package.

1.2 Features and benefits

- Internally matched to 50 Ω
- A gain of 24.8 dB at 950 MHz
- Output power at 1 dB gain compression = -1 dBm
- Supply current = 7.0 mA at a supply voltage of 5 V
- Reverse isolation > 33 dB up to 2150 MHz
- Good linearity with low second order and third order products
- Noise figure = 3.2 dB at 950 MHz
- Unconditionally stable (K > 1)
- No output inductor required

1.3 Applications

- LNB IF amplifiers
- General purpose low noise wideband amplifier for frequencies between DC and 2.2 GHz

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	V _{CC}		
2, 5	GND2	654	
3	RF_OUT		6-
4	GND1	0	4 2, 5
6	RF_IN	□1 □2 □3	h h
			sym052



MMIC wideband amplifier

3. Ordering information

Table 2. Ordering information

Type number	Package	Package						
	Name	Description	Version					
BGA2851	-	plastic surface-mounted package; 6 leads	SOT363					

4. Marking

Table 3. Marking

Type number	Marking code	Description
BGA2851	MC*	* = - : made in Hong Kong
		* = p : made in Hong Kong
		* = W : made in China
		* = t : made in Malaysia

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage	RF input AC coupled	-0.5	+7.0	V
I _{CC}	supply current		-	36	mA
P _{tot}	total power dissipation	T _{sp} = 90 °C	-	200	mW
T _{stg}	storage temperature		-40	+125	°C
Tj	junction temperature		-	125	°C
P _{drive}	drive power		-	+10	dBm

6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-sp)}	thermal resistance from junction to solder point	$P_{tot} = 200 \text{ mW}; T_{sp} = 90 ^{\circ}\text{C}$	300	K/W

7. Characteristics

Table 6. Characteristics

 $V_{CC} = 5.0 \text{ V}; Z_S = Z_L = 50 \Omega; P_i = -40 \text{ dBm}; T_{amb} = 25 \text{ °C}; measured on demo board; unless otherwise specified.}$

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		4.5	5.0	5.5	V
I _{CC}	supply current		6.1	7.0	7.8	mΑ

BGA2851

MMIC wideband amplifier

 Table 6.
 Characteristics ...continued

 $V_{CC} = 5.0 \text{ V; } Z_S = Z_L = 50 \Omega; P_i = -40 \text{ dBm; } T_{amb} = 25 \text{ °C; measured on demo board; unless otherwise specified.}$

F = 950 MHz	Symbol	Parameter	Conditions	Min	Тур	Max	Unit
F = 2150 MHz	Gp	power gain	f = 250 MHz	22.6	23.2	23.7	dB
RLin Input return loss f = 250 MHz 13 15 17 d B RLout 6 = 950 MHz 22 24 27 d B RLout output return loss f = 2150 MHz 11 14 20 d B RLout output return loss f = 250 MHz 12 13 14 d B ISL j = 500 MHz 12 13 14 d B d B ISL j = 500 MHz 40 61 81 d B <t< td=""><td></td><td></td><td>f = 950 MHz</td><td>24.1</td><td>24.8</td><td>25.5</td><td>dB</td></t<>			f = 950 MHz	24.1	24.8	25.5	dB
F = 950 MHz			f = 2150 MHz	23.1	24.6	26	dB
F = 2150 MHz	RLin	input return loss	f = 250 MHz	13	15	17	dB
RLout Dutput return loss f = 250 MHz f = 950 MHz 12 13 14 dB f = 950 MHz 11 14 17 dB f = 950 MHz 11 14 17 dB f = 950 MHz 44 45 47 dB f = 950 MHz 48 45 47 dB dB dB dB dB dB dB d			f = 950 MHz	22	24	27	dB
F = 950 MHz			f = 2150 MHz	11	14	20	dB
F = 2150 MHz	RL _{out}	output return loss	f = 250 MHz	15	19	24	dB
ISL isolation f = 250 MHz 40 61 81 dB f = 950 MHz 44 45 47 dB f = 950 MHz 35 37 40 dB dB dB dB dB dB dB d			f = 950 MHz	12	13	14	dB
F = 950 MHz			f = 2150 MHz	11	14	17	dB
F = 2150 MHz 35 37 40 dB	ISL	isolation	f = 250 MHz	40	61	81	dB
$ \begin{array}{c} {\sf NF} \\ {\sf noise figure} \\ \\ {\sf noise figure} \\ \\ {\sf f} = 950 {\sf MHz} \\ \\ {\sf f} = 950 {\sf MHz} \\ \\ {\sf f} = 2150 {\sf MHz} \\ \\ {\sf f} = 250 {\sf MHz} \\ \\ {\sf f} = 250 {\sf MHz} \\ \\ {\sf f} = 250 {\sf MHz} \\ \\ {\sf f} = 2150 {\sf MHz} \\ \\ \\ {\sf f} = 2150 {\sf MHz} \\ \\ \\ {\sf f} = 2150 {\sf$			f = 950 MHz	44	45	47	dB
$ \begin{array}{c} f = 950 \text{ MHz} \\ f = 2150 \text{ MHz} \\ f = 2150 \text{ MHz} \\ \hline f = 2150 \text{ MHz} \\ \hline f = 2150 \text{ MHz} \\ \hline \\ S = $			f = 2150 MHz	35	37	40	dB
F = 2150 MHz	NF	noise figure	f = 250 MHz	3.5	4.0	4.5	dB
B_3dB			f = 950 MHz	2.8	3.2	3.6	dB
$ \begin{array}{c} K \\ \mathsf$			f = 2150 MHz	2.6	3.0	3.5	dB
$ \begin{array}{c} f = 950 \text{ MHz} \\ f = 2150 \text{ MHz} \\ f = 2150 \text{ MHz} \\ f = 2150 \text{ MHz} \\ f = 250 \text{ MHz} \\ f = 950 \text{ MHz} \\ f = 2150 $	B _{-3dB}	-3 dB bandwidth	3 dB below gain at 1 GHz	2.7	2.9	3.1	GHz
$\begin{array}{c} \text{f} = 2150 \text{ MHz} & 1 & 1.9 & 2.9 \\ \text{P}_{L(\text{sat})} & \text{saturated output power} & \text{f} = 250 \text{ MHz} \\ \text{f} = 950 \text{ MHz} & -2 & -1 & 0 & dB \\ \text{f} = 950 \text{ MHz} & -3 & -1 & 0 & dB \\ \text{f} = 2150 \text{ MHz} & -4 & -3 & -2 & dB \\ \text{f} = 2150 \text{ MHz} & -4 & -3 & -2 & dB \\ \text{f} = 250 \text{ MHz} & -4 & -3 & -3 & dB \\ \text{f} = 950 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 950 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 2150 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 2150 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 2150 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 2150 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 2150 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 2150 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 2150 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -4.5 & -3.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -2.5 & -1.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -2.5 & -1.5 & -1.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -2.5 & -1.5 & -1.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -2.5 & -1.5 & -1.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -2.5 & -1.5 & -1.5 & -1.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -2.5 & -1.5 & -1.5 & -1.5 & -1.5 & dB \\ \text{f} = 250 \text{ MHz} & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 \\ \text{MIM2} & \text{second-order intermodulation distance} & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 \\ \text{MIM2} & \text{second-order intermodulation distance} & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 & -2.5 \\ \text{MIM2} & \text{second-order intermodulation distance} & -2.5 & -$	K	Rollett stability factor	f = 250 MHz	19	29	39	
$\begin{array}{c} {\sf P}_{\sf L(sat)} \\ {\sf P}_{\sf L(sat)} \\ {\sf P}_{\sf L(sat)} \\ {\sf P}_{\sf L(1dB)} \\ {\sf L(1$			f = 950 MHz	3	3	4	
$ \begin{array}{c} \text{f} = 950 \text{ MHz} \\ \text{f} = 2150 \text{ MHz} \\ \text{f} = 2150 \text{ MHz} \\ \text{f} = 250 \text{ MHz} \\ \text{f} = 2150 \text{ MHz}$			f = 2150 MHz	1	1.9	2.9	
$ \begin{array}{c} f = 2150 \; \text{MHz} & -4 & -3 & -2 \; \text{dB} \\ P_{\text{L(1dB)}} & \text{output power at 1 dB gain compression} \\ \hline F = 250 \; \text{MHz} & -4 & -3 & -3 \; \text{dB} \\ \hline f = 950 \; \text{MHz} & -4.5 & -3.5 & -1.5 \; \text{dB} \\ \hline f = 950 \; \text{MHz} & -4.5 & -3.5 & -1.5 \; \text{dB} \\ \hline f = 2150 \; \text{MHz} & -5.5 & -4.5 & -3.5 \; \text{dB} \\ \hline F = 2150 \; \text{MHz} & -5.5 & -4.5 & -3.5 \; \text{dB} \\ \hline P_{\text{drive}} = -43 \; \text{dBm (for each tone)} & -5.5 & -4.5 & -3.5 \; \text{dB} \\ \hline F_{1} = 250 \; \text{MHz; } f_{2} = 251 \; \text{MHz} & -17 & -15 & -13 \; \text{dB} \\ \hline f_{1} = 950 \; \text{MHz; } f_{2} = 951 \; \text{MHz} & -19 & -17 & -15 \; \text{dB} \\ \hline f_{1} = 2150 \; \text{MHz; } f_{2} = 2151 \; \text{MHz} & -23 & -20 & -17 \; \text{dB} \\ \hline F_{1} = 250 \; \text{MHz; } f_{2} = 251 \; \text{MHz} & 6 & 8 & 10 \; \text{dB} \\ \hline f_{1} = 950 \; \text{MHz; } f_{2} = 251 \; \text{MHz} & 6 & 8 & 10 \; \text{dB} \\ \hline f_{1} = 250 \; \text{MHz; } f_{2} = 2151 \; \text{MHz} & 6 & 8 & 10 \; \text{dB} \\ \hline f_{1} = 2150 \; \text{MHz; } f_{2} = 2151 \; \text{MHz} & 6 & 8 & 10 \; \text{dB} \\ \hline f_{1} = 250 \; \text{MHz; } f_{2} = 2151 \; \text{MHz} & -65 & -63 & -61 \; \text{dB} \\ \hline F_{1H} = 250 \; \text{MHz; } f_{2H} = 500 \; \text{MHz} & -65 & -63 & -61 \; \text{dB} \\ \hline f_{1H} = 950 \; \text{MHz; } f_{2H} = 1900 \; \text{MHz} & -51 & -50 & -48 \; \text{dB} \\ \hline \Delta IM2 & \text{second-order intermodulation distance} & F_{\text{drive}} = -43 \; \text{dBm (for each tone)} \\ \hline f_{1} = 250 \; \text{MHz; } f_{2} = 251 \; \text{MHz} & 41 \; 42 \; 42 \; \text{dB} \\ \hline \end{array}$	P _{L(sat)}	saturated output power	f = 250 MHz	-2	-1	0	dBm
$\begin{array}{c} {\sf P}_{\sf L(1dB)} \\ {\sf L(1dB)} \\ {\sf P}_{\sf L(1dB)} \\ {\sf L$			f = 950 MHz	-3	-1	0	dBm
$ \begin{array}{c} & f = 950 \text{ MHz} \\ f = 2150 \text{ MHz} \\ f = 2150 \text{ MHz} \\ & f = 250 \text{ MHz}; f_2 = 251 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 251 \text{ MHz} \\ & f_1 = 950 \text{ MHz}; f_2 = 951 \text{ MHz} \\ & f_1 = 2150 \text{ MHz}; f_2 = 2151 \text{ MHz} \\ & f_1 = 2150 \text{ MHz}; f_2 = 2151 \text{ MHz} \\ & f_1 = 2150 \text{ MHz}; f_2 = 2151 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 251 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 251 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 251 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 251 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 251 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 251 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 2151 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 2151 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 2151 \text{ MHz} \\ & f_1 = 250 \text{ MHz}; f_2 = 2151 \text{ MHz} \\ & f_{1H} = 250 \text{ MHz}; f_{2H} = 1900 \text{ MHz} \\ & f_{1H} = 250 \text{ MHz}; f_{2H} = 1900 \text{ MHz} \\ & f_{1H} = 250 \text{ MHz}; f_{2H} = 250 \text{ MHz} \\ & f_{1H} = 250 \text{ MHz}; f_{2H$			f = 2150 MHz	-4	-3	-2	dBm
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	P _{L(1dB)}	output power at 1 dB gain compression	f = 250 MHz	-4	-3	-3	dBm
$ \begin{array}{c} \text{IP3}_1 \\ \text{IP3}_1 \\ \text{Input third-order intercept point} \\ \end{array} \begin{array}{c} P_{\text{drive}} = -43 \text{ dBm (for each tone)} \\ \hline f_1 = 250 \text{ MHz; } f_2 = 251 \text{ MHz} \\ \hline f_1 = 950 \text{ MHz; } f_2 = 951 \text{ MHz} \\ \hline f_1 = 2150 \text{ MHz; } f_2 = 951 \text{ MHz} \\ \hline f_1 = 2150 \text{ MHz; } f_2 = 2151 \text{ MHz} \\ \hline \end{array} \begin{array}{c} -19 \\ -17 \\ -15 \\ \text{dB} \\ \hline \end{array} \begin{array}{c} -17 \\ -15 \\ \text{dB} \\ \hline \end{array} \\ \end{array} $			f = 950 MHz	-4.5	-3.5	-1.5	dBm
$ \begin{array}{c} f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & -17 & -15 & -13 & \text{dB} \\ \hline f_1 = 950 \text{ MHz}; \ f_2 = 951 \text{ MHz} & -19 & -17 & -15 & \text{dB} \\ \hline f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & -23 & -20 & -17 & \text{dB} \\ \hline f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & -23 & -20 & -17 & \text{dB} \\ \hline IP3_O & \text{output third-order intercept point} & P_{drive} = -43 \text{ dBm (for each tone)} \\ \hline f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & 6 & 8 & 10 & \text{dB} \\ \hline f_1 = 950 \text{ MHz}; \ f_2 = 951 \text{ MHz} & 6 & 8 & 10 & \text{dB} \\ \hline f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & 2.5 & 5.5 & 8.5 & \text{dB} \\ \hline P_{drive} = -40 \text{ dBm} & & & & \\ \hline f_{1H} = 250 \text{ MHz}; \ f_{2H} = 500 \text{ MHz} & -65 & -63 & -61 & \text{dB} \\ \hline f_{1H} = 950 \text{ MHz}; \ f_{2H} = 1900 \text{ MHz} & -51 & -50 & -48 & \text{dB} \\ \hline \Delta IM2 & \text{second-order intermodulation distance} & P_{drive} = -43 \text{ dBm (for each tone)} \\ \hline f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & 41 & 42 & 42 & \text{dB} \\ \hline \end{array} $			f = 2150 MHz	-5.5	-4.5	-3.5	dBm
$ \begin{array}{c} f_1 = 950 \text{ MHz}; \ f_2 = 951 \text{ MHz} & -19 & -17 & -15 & dB \\ \hline f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & -23 & -20 & -17 & dB \\ \hline IP3_O & \text{output third-order intercept point} & P_{drive} = -43 \text{ dBm (for each tone)} \\ \hline f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & 6 & 8 & 10 & dB \\ \hline f_1 = 950 \text{ MHz}; \ f_2 = 951 \text{ MHz} & 6 & 8 & 10 & dB \\ \hline f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & 2.5 & 5.5 & 8.5 & dB \\ \hline P_{L(2H)} & \text{second harmonic output power} & P_{drive} = -40 \text{ dBm} \\ \hline f_{1H} = 250 \text{ MHz}; \ f_{2H} = 500 \text{ MHz} & -65 & -63 & -61 & dB \\ \hline f_{1H} = 950 \text{ MHz}; \ f_{2H} = 1900 \text{ MHz} & -51 & -50 & -48 & dB \\ \hline \Delta IM2 & \text{second-order intermodulation distance} & P_{drive} = -43 \text{ dBm (for each tone)} \\ \hline f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & 41 & 42 & 42 & dB \\ \hline \end{array}$	IP3 _I	input third-order intercept point	P _{drive} = -43 dBm (for each tone)				
$ \begin{array}{c} & f_1 = 2150 \text{ MHz; } f_2 = 2151 \text{ MHz} & -23 & -20 & -17 & dB \\ \hline & IP3_O & \text{output third-order intercept point} & P_{drive} = -43 \text{ dBm (for each tone)} \\ & f_1 = 250 \text{ MHz; } f_2 = 251 \text{ MHz} & 6 & 8 & 10 & dB \\ \hline & f_1 = 950 \text{ MHz; } f_2 = 951 \text{ MHz} & 6 & 8 & 10 & dB \\ \hline & f_1 = 2150 \text{ MHz; } f_2 = 2151 \text{ MHz} & 2.5 & 5.5 & 8.5 & dB \\ \hline & P_{L(2H)} & \text{second harmonic output power} & P_{drive} = -40 \text{ dBm} \\ \hline & f_{1H} = 250 \text{ MHz; } f_{2H} = 500 \text{ MHz} & -65 & -63 & -61 & dB \\ \hline & f_{1H} = 950 \text{ MHz; } f_{2H} = 1900 \text{ MHz} & -51 & -50 & -48 & dB \\ \hline & \Delta IM2 & \text{second-order intermodulation distance} & P_{drive} = -43 \text{ dBm (for each tone)} \\ \hline & f_1 = 250 \text{ MHz; } f_2 = 251 \text{ MHz} & 41 & 42 & 42 & dB \\ \hline \end{array} $			f ₁ = 250 MHz; f ₂ = 251 MHz	-17	-15	-13	dBm
$ \begin{array}{c} \text{IP3}_{O} \\ \text{P}_{drive} = -43 \text{ dBm (for each tone)} \\ \text{f}_{1} = 250 \text{ MHz; } \text{f}_{2} = 251 \text{ MHz} \\ \text{f}_{1} = 950 \text{ MHz; } \text{f}_{2} = 951 \text{ MHz} \\ \text{f}_{1} = 950 \text{ MHz; } \text{f}_{2} = 2151 \text{ MHz} \\ \text{f}_{1} = 2150 \text{ MHz; } \text{f}_{2} = 2151 \text{ MHz} \\ \text{Second harmonic output power} \\ \text{P}_{drive} = -40 \text{ dBm} \\ \text{f}_{1H} = 250 \text{ MHz; } \text{f}_{2H} = 500 \text{ MHz} \\ \text{f}_{2H} = 950 \text{ MHz; } \text{f}_{2H} = 1900 \text{ MHz} \\ \text{F}_{2H} = 1900 \text{ MHz} \\ \text{Second-order intermodulation distance} \\ \text{P}_{drive} = -43 \text{ dBm (for each tone)} \\ \text{f}_{1} = 250 \text{ MHz; } \text{f}_{2} = 251 \text{ MHz} \\ \text{41} 42 42 \text{dB} \\ \end{array} $			f ₁ = 950 MHz; f ₂ = 951 MHz	-19	-17	-15	dBm
$\begin{array}{c} f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & 6 & 8 & 10 & \text{dB} \\ f_1 = 950 \text{ MHz}; \ f_2 = 951 \text{ MHz} & 6 & 8 & 10 & \text{dB} \\ f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & 2.5 & 5.5 & 8.5 & \text{dB} \\ \hline P_{L(2H)} & \text{second harmonic output power} & P_{drive} = -40 \text{ dBm} \\ \hline f_{1H} = 250 \text{ MHz}; \ f_{2H} = 500 \text{ MHz} & -65 & -63 & -61 & \text{dB} \\ \hline f_{1H} = 950 \text{ MHz}; \ f_{2H} = 1900 \text{ MHz} & -51 & -50 & -48 & \text{dB} \\ \hline \Delta IM2 & \text{second-order intermodulation distance} & P_{drive} = -43 \text{ dBm (for each tone)} \\ \hline f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & 41 & 42 & 42 & \text{dB} \\ \hline \end{array}$			f ₁ = 2150 MHz; f ₂ = 2151 MHz	-23	-20	-17	dBm
$\begin{array}{c} f_1 = 950 \text{ MHz}; \ f_2 = 951 \text{ MHz} & 6 & 8 & 10 & \text{dB} \\ f_1 = 2150 \text{ MHz}; \ f_2 = 2151 \text{ MHz} & 2.5 & 5.5 & 8.5 & \text{dB} \\ \hline P_{L(2H)} & \text{second harmonic output power} & P_{drive} = -40 \text{ dBm} & & & & \\ \hline f_{1H} = 250 \text{ MHz}; \ f_{2H} = 500 \text{ MHz} & -65 & -63 & -61 & \text{dB} \\ \hline f_{1H} = 950 \text{ MHz}; \ f_{2H} = 1900 \text{ MHz} & -51 & -50 & -48 & \text{dB} \\ \hline \Delta IM2 & \text{second-order intermodulation distance} & P_{drive} = -43 \text{ dBm (for each tone)} & & & & \\ \hline f_1 = 250 \text{ MHz}; \ f_2 = 251 \text{ MHz} & 41 & 42 & 42 & \text{dB} \\ \hline \end{array}$	IP3 _O	output third-order intercept point	P _{drive} = -43 dBm (for each tone)				
$f_{1} = 2150 \text{ MHz}; \ f_{2} = 2151 \text{ MHz} \qquad 2.5 \qquad 5.5 \qquad 8.5 \qquad \text{dB}$ $P_{L(2H)} \qquad \text{second harmonic output power} \qquad P_{drive} = -40 \text{ dBm} \qquad \qquad$			f ₁ = 250 MHz; f ₂ = 251 MHz	6	8	10	dBm
$\begin{array}{c} P_{L(2H)} \\ \end{array} \ \ \begin{array}{c} \text{second harmonic output power} \\ \end{array} \ \ \begin{array}{c} P_{drive} = -40 \text{ dBm} \\ \\ \hline f_{1H} = 250 \text{ MHz}; f_{2H} = 500 \text{ MHz} \\ \hline f_{1H} = 950 \text{ MHz}; f_{2H} = 1900 \text{ MHz} \\ \end{array} \ \ \begin{array}{c} -65 \\ -63 \\ -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \\ \hline f_{1H} = 950 \text{ MHz}; f_{2H} = 1900 \text{ MHz} \\ \hline \\ \end{array} \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \\ \hline \\ \hline \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \\ \hline \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \\ \hline \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \end{array} \ \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -40 \text{ dBm} \\ \hline \end{array} \ \ \ \begin{array}{c} -51 \\ -50 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ -50 \\ -48 \\ \end{array} \ \ \begin{array}{c} -51 \\ -50 \\ $			f ₁ = 950 MHz; f ₂ = 951 MHz	6	8	10	dBm
$f_{1H} = 250 \text{ MHz}; f_{2H} = 500 \text{ MHz} \qquad -65 \qquad -63 \qquad -61 \qquad \text{dB}$ $f_{1H} = 950 \text{ MHz}; f_{2H} = 1900 \text{ MHz} \qquad -51 \qquad -50 \qquad -48 \qquad \text{dB}$ $\Delta \text{IM2} \qquad \text{second-order intermodulation distance} \qquad P_{\text{drive}} = -43 \text{ dBm (for each tone)}$ $f_{1} = 250 \text{ MHz}; f_{2} = 251 \text{ MHz} \qquad \qquad 41 \qquad 42 \qquad 42 \qquad \text{dB}$			f ₁ = 2150 MHz; f ₂ = 2151 MHz	2.5	5.5	8.5	dBm
$f_{1H} = 950 \text{ MHz}; f_{2H} = 1900 \text{ MHz} \qquad -51 \qquad -50 \qquad -48 \text{dB}$ $\Delta \text{IM2} \qquad \text{second-order intermodulation distance} \qquad P_{\text{drive}} = -43 \text{ dBm (for each tone)} \qquad \qquad$	P _{L(2H)}	second harmonic output power	P _{drive} = -40 dBm				
$\Delta IM2 \qquad \text{second-order intermodulation distance} \qquad P_{\text{drive}} = -43 \text{ dBm (for each tone)} \qquad \qquad$			f _{1H} = 250 MHz; f _{2H} = 500 MHz	-65	-63	-61	dBm
$f_1 = 250 \text{ MHz}; f_2 = 251 \text{ MHz}$ 41 42 42 dB			f _{1H} = 950 MHz; f _{2H} = 1900 MHz	-51	-50	-48	dBm
	ΔΙΜ2	second-order intermodulation distance	$P_{drive} = -43 \text{ dBm (for each tone)}$				
			f ₁ = 250 MHz; f ₂ = 251 MHz	41	42	42	dBc
$f_1 = 950 \text{ MHz}; f_2 = 951 \text{ MHz}$ 42 43 dB			f ₁ = 950 MHz; f ₂ = 951 MHz	42	42	43	dBc

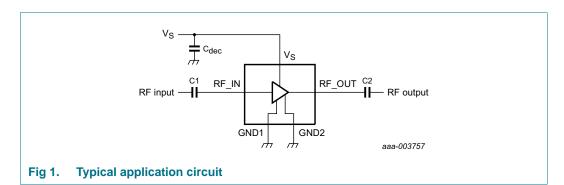
MMIC wideband amplifier

8. Application information

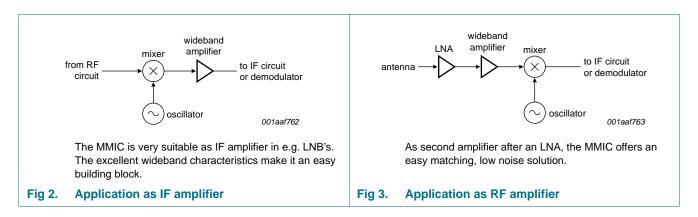
<u>Figure 1</u> shows a typical application circuit for the BGA2851 MMIC. The device is internally matched to $50~\Omega$, and therefore does not need any external matching. The value of the input and output DC blocking capacitors C2 and C3 should not be more than 100 pF for applications above 100 MHz. However, when the device is operated below 100 MHz, the capacitor value should be increased.

The location of the 470 pF supply decoupling capacitor (C_{dec}) can be precisely chosen for optimum performance.

The PCB top ground plane, connected to pins 2, 4 and 5 must be as close as possible to the MMIC, preferably also below the MMIC. When using via holes, use multiple via holes as close as possible to the MMIC.



8.1 Application examples



8.2 Tables

Table 7. Supply current over temperature and supply voltages *Typical values.*

Symbol	Parameter	Conditions	T _{amb} (°C)			Unit
			-40	+25	+85	
I _{CC}	supply current	V _{CC} = 4.5 V	6.40	6.00	5.60	mA
		V _{CC} = 5.0 V	7.10	6.70	6.30	mA
		V _{CC} = 5.5 V	7.80	7.40	7.00	mA

BGA2851

MMIC wideband amplifier

Table 8. Second harmonic output power over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb} (°C)		Unit	
			-40	+25	+85	
P _{L(2H)}	second harmonic output power	$f = 250 \text{ MHz}; P_{drive} = -40 \text{ dBm}$				
		V _{CC} = 4.5 V	-58	-63	-65	dBm
		V _{CC} = 5.0 V	-59	-63	-65	dBm
		V _{CC} = 5.5 V	-59	-62	-64	dBm
		f = 950 MHz; P _{drive} = -40 dBm				
		V _{CC} = 4.5 V	-48	-51	-54	dBm
		V _{CC} = 5.0 V	-47	-50	-53	dBm
		V _{CC} = 5.5 V	-47	-49	-53	dBm

Table 9. Input power at 1 dB gain compression over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	ditions T _{amb} (°C)			Unit
			-40	+25	+85	
P _{i(1dB)}	input power at 1 dB gain compression	f = 250 MHz				
		V _{CC} = 4.5 V	-26	-26	-26	dBm
		V _{CC} = 5.0 V	-26	-26	-26	dBm
		V _{CC} = 5.5 V	-25	-26	-26	dBm
		f = 950 MHz				
		V _{CC} = 4.5 V	-28	-28	-28	dBm
		V _{CC} = 5.0 V	-28	-28	-28	dBm
		V _{CC} = 5.5 V	-27	-27	-27	dBm
		f = 2150 MHz				
		V _{CC} = 4.5 V	-30	-29	-29	dBm
		V _{CC} = 5.0 V	-30	-29	-29	dBm
		V _{CC} = 5.5 V	-30	-30	-30	dBm

MMIC wideband amplifier

Table 10. Output power at 1 dB gain compression over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb}	Unit		
			-40	+25	+85	
P _{L(1dB)}	output power at 1 dB gain compression	f = 250 MHz				
		V _{CC} = 4.5 V	-4	-5	-5	dBm
		V _{CC} = 5.0 V	-3	-3	-4	dBm
		$V_{CC} = 5.5 \text{ V}$	-2	-3	-3	dBm
		f = 950 MHz				
		V _{CC} = 4.5 V	-3.5	-4.5	-5.5	dBm
		$V_{CC} = 5.0 \text{ V}$	-2.5	-3.5	-4.5	dBm
		$V_{CC} = 5.5 \text{ V}$	-1.5	-2.5	-3.5	dBm
		f = 2150 MHz				
		$V_{CC} = 4.5 \text{ V}$	-4.5	-5.5	-7.5	dBm
		V _{CC} = 5.0 V	-3.5	-4.5	-6.5	dBm
		$V_{CC} = 5.5 \text{ V}$	-2.5	-4.5	-5.5	dBm

Table 11. Saturated output power over temperature and supply voltages *Typical values.*

Symbol	Parameter	Conditions	T _{amb}	(°C)		Unit
			-40	+25	+85	
P _{L(sat)}	saturated output power	f = 250 MHz				
		V _{CC} = 4.5 V	-1	-2	-3	dBm
		V _{CC} = 5.0 V	0	-1	-2	dBm
		V _{CC} = 5.5 V	+1	0	-1	dBm
		f = 950 MHz				
		V _{CC} = 4.5 V	-2	-2	-3	dBm
		V _{CC} = 5.0 V	-1	-1	-2	dBm
		V _{CC} = 5.5 V	1	0	0	dBm
		f = 2150 MHz				
		V _{CC} = 4.5 V	-3	-4	-5	dBm
		V _{CC} = 5.0 V	-2	-3	-5	dBm
		V _{CC} = 5.5 V	-1	-3	-4	dBm

MMIC wideband amplifier

Table 12. Second-order intermodulation distance over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb} (°C)			Unit
			-40	+25	+85	
ΔΙΜ2	second-order intermodulation distance	$f_1 = 250 \text{ MHz};$ $f_2 = 251 \text{ MHz};$ $P_{drive} = -43 \text{ dBm}$				
		V _{CC} = 4.5 V	47	42	36	dBc
		V _{CC} = 5.0 V	48	42	37	dBc
		V _{CC} = 5.5 V	48	42	38	dBc
		$f_1 = 950 \text{ MHz};$ $f_2 = 951 \text{ MHz};$ $P_{drive} = -43 \text{ dBm}$				
		V _{CC} = 4.5 V	45	44	36	dBc
		V _{CC} = 5.0 V	49	42	36	dBc
		V _{CC} = 5.5 V	47	41	36	dBc

Table 13. Output third-order intercept point over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb}	T _{amb} (°C)		
			-40	+25	+85	
IP3 _O	output third-order intercept point	$f_1 = 250 \text{ MHz};$ $f_2 = 251 \text{ MHz};$ $P_{drive} = -43 \text{ dBm}$				
		V _{CC} = 4.5 V	9	7	5	dBm
		V _{CC} = 5.0 V	10	8	7	dBm
		V _{CC} = 5.5 V	11	9	8	dBm
		$f_1 = 950 \text{ MHz};$ $f_2 = 951 \text{ MHz};$ $P_{drive} = -43 \text{ dBm}$				
		V _{CC} = 4.5 V	8	6	5	dBm
		V _{CC} = 5.0 V	10	8	6	dBm
		V _{CC} = 5.5 V	11	9	7	dBm
		$f_1 = 2150 \text{ MHz};$ $f_2 = 2151 \text{ MHz};$ $P_{drive} = -43 \text{ dBm}$				
		V _{CC} = 4.5 V	6	4	2	dBm
		V _{CC} = 5.0 V	7.5	5.5	3.5	dBm
		V _{CC} = 5.5 V	8	6	4	dBm

Table 14. –3 dB bandwidth over temperature and supply voltages *Typical values*.

Symbol	Parameter	Conditions	T _{amb} (°	Unit		
			-40	+25	+85	
B _{-3dB} -3	-3 dB bandwidth	$V_{CC} = 4.5 \text{ V}$	3.02	2.87	2.69	GHz
		$V_{CC} = 5.0 \text{ V}$	3.05	2.90	2.72	GHz
		$V_{CC} = 5.5 \text{ V}$	3.07	2.92	2.74	GHz

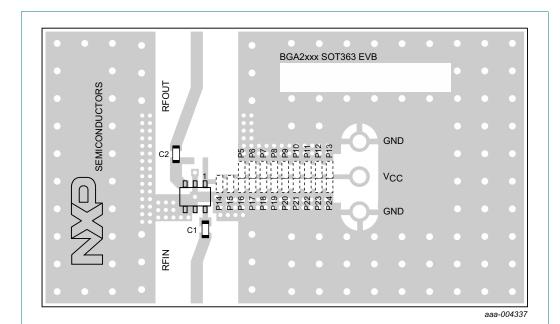
BGA2851

All information provided in this document is subject to legal disclaimers.

© NXP Semiconductors N.V. 2015. All rights reserved.

MMIC wideband amplifier

9. Test information



For decoupling a decoupling capacitor (C_{dec}) is used on one of the positions of P5 to P24. The results mentioned in this data sheet have been obtained using the decoupling capacitor C_{dec} on position P22. The distance between the center of pin 1 and the center of position P22 is 7.43 mm.

Fig 4. PCB layout and demo board with components

Table 15. List of components used for the typical application

Component	Description	Value	Dimensions	Remarks
C1, C2	multilayer ceramic chip capacitor	470 pF	0603	X7R RF coupling capacitor
P5 to P24 [1]	position for multilayer ceramic chip capacitor C _{dec}	470 pF	0603	X7R RF decoupling capacitor
IC1	BGA2851 MMIC	-	SOT363	

[1] For decoupling a decoupling capacitor (C_{dec}) is used on one of the positions of P5 to P24. The results mentioned in this data sheet have been obtained using the decoupling capacitor C_{dec} on position P22.

MMIC wideband amplifier

10. Package outline

Plastic surface-mounted package; 6 leads

SOT363

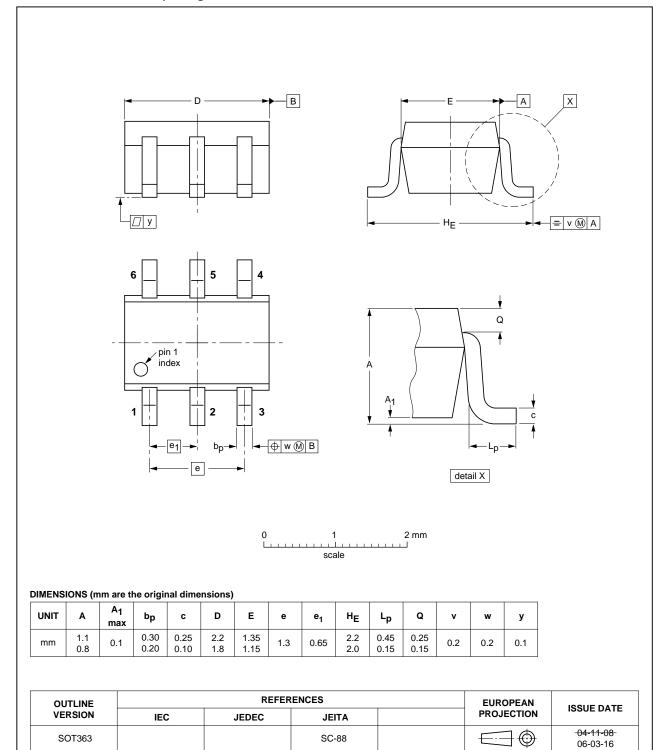


Fig 5. Package outline SOT363

BGA2851

MMIC wideband amplifier

11. Abbreviations

Table 16. Abbreviations

Acronym	Description
IF	Intermediate Frequency
LNA	Low-Noise Amplifier
LNB	Low-Noise Block converter
PCB	Printed-Circuit Board
SMD	Surface Mounted Device

12. Revision history

Table 17. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BGA2851 v.3	20150713	Product data sheet	-	BGA2851 v.2
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. Legal texts have been adapted to the new company name where appropriate. 			
BGA2851 v.2	20130905	Product data sheet	-	BGA2851 v.1
BGA2851 v.1	20111020	Product data sheet	-	-

MMIC wideband amplifier

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

13.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

13.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

BGA2851

All information provided in this document is subject to legal disclaimers.

© NXP Semiconductors N.V. 2015. All rights reserved.

MMIC wideband amplifier

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

13.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

14. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

BGA2851 NXP Semiconductors

MMIC wideband amplifier

15. Contents

1	Product profile
1.1	General description
1.2	Features and benefits
1.3	Applications
2	Pinning information 1
3	Ordering information
4	Marking 2
5	Limiting values
6	Thermal characteristics 2
7	Characteristics
8	Application information 4
8.1	Application examples
8.2	Tables
9	Test information 8
10	Package outline
11	Abbreviations
12	Revision history
13	Legal information
13.1	Data sheet status
13.2	Definitions
13.3	Disclaimers
13.4	Trademarks12
14	Contact information 12
15	Contents 13

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.



Мы молодая и активно развивающаяся компания в области поставок электронных компонентов. Мы поставляем электронные компоненты отечественного и импортного производства напрямую от производителей и с крупнейших складов мира.

Благодаря сотрудничеству с мировыми поставщиками мы осуществляем комплексные и плановые поставки широчайшего спектра электронных компонентов.

Собственная эффективная логистика и склад в обеспечивает надежную поставку продукции в точно указанные сроки по всей России.

Мы осуществляем техническую поддержку нашим клиентам и предпродажную проверку качества продукции. На все поставляемые продукты мы предоставляем гарантию.

Осуществляем поставки продукции под контролем ВП МО РФ на предприятия военно-промышленного комплекса России, а также работаем в рамках 275 ФЗ с открытием отдельных счетов в уполномоченном банке. Система менеджмента качества компании соответствует требованиям ГОСТ ISO 9001.

Минимальные сроки поставки, гибкие цены, неограниченный ассортимент и индивидуальный подход к клиентам являются основой для выстраивания долгосрочного и эффективного сотрудничества с предприятиями радиоэлектронной промышленности, предприятиями ВПК и научноисследовательскими институтами России.

С нами вы становитесь еще успешнее!

Наши контакты:

Телефон: +7 812 627 14 35

Электронная почта: sales@st-electron.ru

Адрес: 198099, Санкт-Петербург,

Промышленная ул, дом № 19, литера Н,

помещение 100-Н Офис 331